

4D Reconstruction

needs and challenges

Mini workshop: Trig & Reco Input for European Strategy for Particle Physics 2025

- Wednesday 27 Nov 2024, 14:00 → 16:05 Europe/Zurich
- **?** ZOOM

Description Discussion around HEP Software Foundation input to European Strategy for Particle Physics Update 2025 on *common challenges* in HEP for Software Trigger and Reconstruction.

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AT THE HEART OF COLLIDER PHYSICS: CHALLENGES AND BREAKTHROUGHS













The top quark and the silicon strip era







The Higgs boson (and more!) and the silicon pixel era





TRACKS AND VERTICES

The building blocks physics events colliders



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UNFOLDING A NEW DIMENSION

 Addition of timing layers to HEP detectors growing area of interest



 Next step in advancing technologies are real 4-dimensional silicon trackers (resolution of O(10 μm) & O(10 ps)) **LHCb looks forward to the 2030s** 1 March 2023

• Excellent opportunity during HL-LHC and, in particular, for future energy frontier trackers



TIMING LAYERS AT HL-LHC

ATLAS High Granularity Timing Detector



CMS MIP Timing Detector

LGADs to cover the forward pseudorapidity region $2.4 < |\eta| < 4.0$

LGADs and crystals for hermetic coverage up to $|\eta| < 3.0$

4D TRACKING USE-CASES

HL-LHC Beyond Run 4



4D tracking for replacements/upgrades?

Electron-positron colliders



Timing layers for flavour tagging, particle ID, and LLP searches

Muon collider / hadron colliders



up suppression (*hh*)

27.11.24

THE PILE-UP CHALLENGE@ HADRON COLLIDERS



2.5 mm

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THE PILE-UP CHALLENGE@ HADRON COLLIDERS



Misassociations of pile-up tracks to the hard-scatter vertex is likely. If we could **determine** not only the position but also **the time** at which the hard-scatter occurred, pile-up contamination would be strongly reduced...



IMPACT ON EXPERIMENTAL PERFORMANCE



IMPACT ON EXPERIMENTAL PERFORMANCE



long-term simulation effort is potentially launched as a second step

4-DIMENSIONAL TRACKING & *b*-TAGGING



Interesting potential *HH* sensitivity increase!

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Could boost the reach of rarer HH production modes, e.g. *ttHH*

4-DIMENSIONAL TRACKING & *b*-TAGGING

~60% of the times



 $\int_{0}^{10} \int_{0}^{10} \frac{ATLAS}{\sqrt{5}} = 14 \text{ TeV} (\mu) = 200 \text{ GNT 30pc}$

This is just one highlight, much more on the determination of the vertex time, flavour tagging, VBF physics and LLPs is in the extra slides. See also previous <u>HSF talk</u> from CMS.

> N.B. We will have a dedicated HSF seminar in February with contributions from ATLAS & CMS <u>https://indico.cern.ch/event/1465929/</u>



Interesting potential HH sensitivity increase!

V.M.M.CAIRO Could boost the reach of rarer HH production modes, e.g. *ttHH*

3D

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LHCb UPGRADE II

Framework <u>TDR</u>, R. Quagliani's <u>slides</u>, T. Evans' <u>slides</u>





Need to reach a resolution $\mathcal{O}(10)$ ps, while dealing with

- Huge data rates (> 50 Tb/s for whole detector, > 100 kHz for hottest pixels)
- Extreme radiation tolerance $(> 2 \times 10^{16} n_{eq}/\text{ cm}^2)$

and

• Keeping excellent spatial resolution ($\sim 10 \,\mu m$) \implies low material budget



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FUTURE hh COLLIDERS

- The extreme scenario in terms of pile-up challenge is FCC-hh with O(1000) pile-up
- Impact of timing information was studied in the past





Extreme timing resolution of 5 - 10 ps per track is essential to keep the effective pileup low and prevent the merging of unrelated vertices

BEYOND HADRON COLLIDERS

FUTURE μ COLLIDERS

See more <u>here</u>

- Large beam-induced background from muon decays and showering of electrons on shielding
 - mostly electrons/photons, some neutrons
 - significant out-of-time component
 - coming from "all" directions!
- Full 4D-tracking is a requirement, not an option

Sub-Detector MAIA/MUSIC Units	Technology	# Layers /Rings	"Cell" Size µm ²	Sensor Thickness µm	Hit Time Resolution ps	Signal Time Window ns
Vertex Barrel	Pixels	4*/5	25 x 25	50	30	[-0.18, 15.0]
Vertex Endcap	Pixels	4	25 x 25	50	30	[-0.18, 15.0]
Inner Barrel	Macro-Pixels	3	50 x 1000	100	60	[-0.36, 15.0]
Inner Endcap	Macro-Pixels	7	50 x 1000	100	60	[-0.36, 15.0]
Outer Barrel	Macro-Pixels	3	50 x 10000	100	60	[-0.36, 15.0]
Outer Endcap	Macro-Pixels	4	50 x 10000	100	60	[-0.36, 15.0]







FUTURE e^+e^- COLLIDERS See more here

- Clean environment, but physics measurements targeting very high precision, different applications of timing
- Some of the detector concepts integrate timing envelopes around main tracker
 - Can enable/improve TOF-based PID, flavour tagging, & searches for Long Lived Particles





Heavy neutral leptons, axion-like particles, and exotic Higgs boson decays



"In addition, calorimeter and precision timing variables will be extremely helpful to include in this study of ALPs that decay to photons."

2203.05502

FUTURE EIC Z. Ye's slides

- The Electron-Ion Collider (2031+) is among the highest priority of US Nuclear Physics
- Electron-Proton and -Ion Collider detector (ePIC) concept includes PID capabilities via AC-LGAD layers (also vertex identification for far-forward hadrons)



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ACTS-BASED RECONSTRUCTION

A Common Tracking Software (ACTS): already adopted in Run 3 for ATLAS vertexing and employed by several other experiments (running and/or future):

- Embedded time measurement as one of the 6 track parameters
- We can perform detailed hit-to-track and track-to-vertex association studies
- Offer a generic **Open Data Detector (ODD)** layout for a silicon tracker
- Ongoing work to translate the FCC-hh tracker into ACTS, in particular to <u>detray</u>/<u>traccc</u>
- 4D vertex finding and fitting implemented, more on tracking here

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 Jet reconstruction algorithms (e.g. Fast Jet) can and have been interfaced with ACTS to build particle level jets, which can in turn be used for jet and flavour tagging studies



A WORD ON TECHNOLOGY

- Several groups working on developing 4D tracking technologies that could meet the HL-LHC specifications should such replacements take place, but intensive R&D is still required and several options are being looked at:
 - Hybrid Low Gain (DC, AC-coupled), monolithic Low Gain, hybrid No Gain (Planar, 3D), monolithic No Gain (CMOS), and many more!
- Radiation Hardness is a key challenge
 - At the HL-LHC the innermost layers are placed at O(30) mm from the IP and will receive doses of O(10) MGy after 2 ab-1 of data
 - At FCC-hh, radius of O(20) mm, radiation levels 0.4 GGy expected after 30 ab⁻¹ and a fluence of 6 × 10¹⁷ per cm² 1 MeV neq.
 - These are approximately 30 times (600 times) more intense than the environment at the HL-LHC (LHC).
 - Dedicated R&D efforts for extreme timing resolutions and radiation hardness is needed. These will also be correlated with the spatial resolution and the changes in the material budget, thus analyzing the interplay among them is of key interest

IN VIEW OF THE ESPP UPDATE

- For Snowmass, we released a document (<u>2203.13900</u>) that "reviews the impact of integrating 4D tracking capabilities on several physics benchmarks both in potential upgrades of the HL-LHC experiments and in several detectors at future colliders, and summarizes the currently available sensor technologies as well as electronics, along with their limitations and directions for R&D."
- Substantial work has been performed since then, with promising advancements in reconstruction
 - See proof-of-concepts from ATLAS, LHCb, etc
 - Reconstruction for detectors at Muon Colliders
 - Generic 4D tracking in ACTS, crucial for fast turnarounds
- Technologies have also advanced
- Input to the **ESPP could focus on these aspects**, i.e. what's new since Snowmass

CONCLUSIONS

- We are broadly investigating 4D tracking in various contexts: HL-LHC, FCC-ee ToF, muC, and FCC-hh, with extensive usage of ACTS ODD
 - Challenges change with the collider environment:
 - e^+e^- clean environment, but high precision requirements, timing for e.g. TOF
 - HL-LHC upgrades, MuC, FCC-hh, etc: increasingly busy environments, critical to identify hard scatter
 - Differences in backgrounds and collider can imply different strategies but synergies exist
- **4D Tracking is a unique feature to boost the experimental physics reach**, and can be combined with advancements in track reconstruction algorithms
- Both algorithms and technologies are being developed and offer interesting opportunities for HL-LHC and, even more so, future colliders!



THANK YOU!



E.T. Exploring Tracking-lands, by F. Cairo

Valentina Maria Martina Cairo



EXTRA SLIDES



UNFOLDING A NEW DIMENSION

Addition of timing layers to HEP detectors growing area of interest



High Granularity Timing Detector



New handles to improve event reconstruction in the forward region, but limited by its reduced η acceptance...

Can we maximize the ATLAS physics potential beyond Run 4 by <u>extending the timing coverage</u> to the full <u>n acceptance?</u>



CERN-LHCC-2019-00 CMS-TDR-020 29 March 2019

ATLAS

A COMPARISON WITH CMS' MIP TIMING DETECTOR

From CMS MTD TDR: "The MTD will give timing information for MIPs with 30–40 ps resolution at the beginning of HL-LHC operation in 2026, degrading slowly as a result of radiation damage to 50–60 ps by the end of HL-LHC operations."

Table 1.1: Expected scientific impact of the MIP Timing Detector, taken from Ref. [8].					
Signal	Physics measurement	MTD impact			
$H \rightarrow \gamma \gamma$ and	+15-25% (statistical) precision on the cross section	Isolation and			
$H \rightarrow 4$ leptons	\rightarrow Improve coupling measurements	Vertex identification			
$VBF \rightarrow H \rightarrow \tau \tau$	+30% (statistical) precision on cross section	Isolation			
	\rightarrow Improve coupling measurements	VBF tagging, $p_{\rm T}^{\rm miss}$			
HH	+20% gain in signal yield	Isolation			
	\rightarrow Consolidate searches	b-tagging			
EWK SUSY	+40% background reduction	MET			
	ightarrow 150 GeV increase in mass reach	b-tagging			
Long-lived	Peaking mass reconstruction	$\beta_{\rm LLP}$ from timing of			
particles (LLP)	\rightarrow Unique discovery potential	displaced vertices			

about 200. The integrated luminosity \times efficiency is increased and this gain is equivalent to collecting data for three additional years beyond the ten year run planned for the HL-LHC.

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CMS' MIP TIMING DETECTOR



Beyond Run 4, CMS is also considering to add <u>timing layers</u> in the innermost part of the tracker.

UNFOLDING A NEW DIMENSION

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- Excellent opportunity during HL-LHC and, in particular, for future energy frontier trackers
- First exploratory studies in ATLAS
 - Also looked at in LHCb



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ACTS-BASED STUDIES

 Furthermore, jet reconstruction algorithms (e.g. Fast Jet) can and have been interfaced with ACTS to build particle level jets, which can in turn be used for jet and flavour tagging studies



Incoming student to complete the studies with timing information

THE RECONSTRUCTION CHAIN



THE RECONSTRUCTION CHAIN



DETERMINING THE VERTEX TIME

- With 4D tracking, each charged particle would have a timestamp
- Determining vertex time crucial for reconstruction/identification of other objects, e.g. b-jets





Time clustering a posteriori on 3D vertex → spurious tracks removed effectively!

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DETERMINING THE VERTEX TIME

- With 4D tracking, each charged particle would have a timestamp
- Determining vertex time crucial for reconstruction/identification of other objects, e.g. b-jets



Excellent vertex time resolution can be achieved

DETERMINING THE VERTEX TIME

- With 4D tracking, each charged particle would have a timestamp
- Determining vertex time crucial for reconstruction/identification of other objects, e.g. b-jets





The better the track-time resolution, the more PU-robust the vertex time resolution

*I-*jet

____ /-jet no PU **D**jet no PU

🔲 b-jet

-50

0

50

100

36

150

200

THE KEY FEATURES FOR *b*-TAGGING



Long lifetime of B-hadrons requires selecting tracks with large IPs \rightarrow large selection windows around the V.M.M.CAIRO longitudinal IP \rightarrow more pile-up contamination that can lead to fake secondary vertices
GNT – 4D *b*-TAGGING



time significance is built

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GNT – 4D *b*-**TAGGING**



Known track and vertex time, a track time significance is built



Interesting potential sensitivity increase for Higgs physics, in particular **HH**, whose observation is a high-priority goal for HL-LHC

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HH PROSPECTS



e.g. 77% to 82% → ~0.3σ improvement (more than 500 fb-1 of data!)

N.B. this plot was made by scaling to the full HL-LHC luminosity

OTHER PHYSICS CASES

- VBF H → inv extensively studied at the time of the <u>HGTD TDR</u>, results still valid
- Long Lived Particles studied in the PubNote, in particular *delayed photons*
- Other applications to be further explored, e.g. c-tagging (similar considerations as for b-tagging), tau reconstruction and identification, etc



OTHER PHYSICS CASES

$VBF H \rightarrow inv$





OTHER PHYSICS CASES

ECal signal $t_{PV \rightarrow ECal} \gamma \gamma \gamma \tau t_{PV \rightarrow NLSP \rightarrow ECal} \tau_{PV} \tau_{HS} NLSP LSP \tau_{LSP} \tau_{SP} \tau_{S$

 $t_{\text{ECal}}^{\text{Measured}} = t_0 + t_{\text{IP} \rightarrow \text{ECal}}$

 $\Delta t^{\text{Reconstructed}} = t_{\text{ECal}}^{\text{Measured}} - t_{\text{IP} \rightarrow \text{ECal}}^{\text{Reconstructed}} - t_0^{\text{Reconstructed}}$



Delayed photons

VBF HIGGS \rightarrow INVISIBLE

VBF $H \rightarrow inv$ extensively studied at the time of the <u>HGTD TDR</u>, results still valid!



Fig. 3.25

Normalized signal over background gain relative to ITkonly pileup jet suppression performance, as a function of the additional pileup jet rejection from HGTD. The solid black (dotted red) line represents the HGTD improvement from the CF (FF) event topologies separately. The dotted blue line shows the total improvement when the combined HGTD+ITk pileup suppression algorithm is applied to all jets in the event.

VERTEX TO

The average spatial pile-up density is defined as:

$$\langle \rho \rangle(z_{HS}) = \frac{\langle \mu \rangle}{\sqrt{2\pi}\sigma_z} \exp\left(-\frac{z_{HS}^2}{2\sigma_z^2}\right)$$

 $\langle \rho \rangle(t_{HS}) = \frac{\langle \mu \rangle}{\sqrt{2\pi}\sigma_t} \exp\left(-\frac{t_{\rm HS}^2}{2\sigma_t^2}\right)$

The average temporal pile-up density is defined as:

$$a = 14 \text{ TeV}, t\bar{t}, (\mu) = 200$$

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GNN



GNN

Track Variables	GN1 ITk	GN1 ITk time
d0	х	х
z0SinTheta	х	х
σ(Theta)	х	х
qOverP	x	х
σ(qOverP)	х	х
φ	x	х
σ(φ)	x	х
signed d0 significance	x	х
signed z0 significance	x	х
Δη(trk, jet)	х	х
Δφ(trk, jet)	x	х
n pix hits	x	х
• n pix hits (11 variables)	x	х
dt		х
nPixHits nStripHits nInnermostPixHits nNextToInnermostPixHits nInnermostPixShared nInnermostPixSplit nPixShared nPixSplit nStripShared nPixHoles	Number of pixel hits Number of strip hits Number of hits from the Number of hits from the Number of shared hits fro Number of split hits fro Number of shared pixel Number of split pixel hi Number of shared strip Number of pixel pixel he	e innermost pixel layer e next-to-innermost pixel layer from the innermost pixel layer m the innermost pixel layer hits its hits

4D TRACKING



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4D FTAG



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4D FTAG





4D FTAG

A complete simulation is needed for an accurate study

We investigated independently the impact of missing hits and mistag hits showing that the performances get degraded mostly at low b-jet efficiencies

missing hit: assuming time only in 2nd layer; if a track has no hit the significance of the track is randomly emulated as HS

mistag hit: for tracks with Truth Match Probability < 80% the significance is randomly emulated as PU



Presently explored options

The present R&D in position sensitive timing detectors shows the same variety that is present in standard silicon sensors. In the following, I will cover a few examples from this chart.



https://indico.cern.ch/event/797047/contributions/3638198/attachments/2308674/3928223/Position_sensitive_timing.pdf

- AC-LGADs
 - Characterization of BNL and HPK AC-LGAD sensors with a 120 GeV proton beam (R. Heller et al.)
 - <u>https://arxiv.org/abs/2201.07772</u>
 - "We present a world's first demonstration of silicon sensors in a test beam that simultaneously achieve better than 5–10 μm position and 30 ps time resolution."

Name	Pitch	Primary signal amp.	Position res.	Time res.
Unit	μm	mV	μm	ps
BNL 2020	100	101 ± 10	≤6	29 ± 1
BNL 2021 Narrow	100	104 ± 10	≤9	32 ± 1
BNL 2021 Medium	150	136 ± 13	≤11	30 ± 1
BNL 2021 Wide	200	144 ± 14	≤9	33 ± 1
HPK C–2	500	128 ± 12	22 ± 1	30 ± 1
HPK B–2	500	95 ± 10	24 ± 1	27 ± 1

Monolithics (<u>https://arxiv.org/pdf/2404.12885</u>)

silicon pixel detector without internal gain layer
T. Moretti, ^a M. Milanesio, ^a R. Cardella, ^a T. Kugathasan, ^a A. Picardi, ^{a,b} I. Semendyaev, ^a M. Elviretti, ^c H. Rücker, ^c K. Nakamura, ^d Y. Takubo, ^d M. Togawa, ^d F. Cadoux, ^a R. Cardarelli, ^a L. Cecconi, ^a S. Débieux, ^a Y. Favre, ^a C. A. Fenoglio, ^e D. Ferrere, ^a S. Gonzalez-Sevilla, ^a L. Iodice, ^a R. Kotitsa, ^{a,b} C. Magliocca, ^a M. Nessi, ^{a,b} A. Pizarro-Medina, ^a J. Sabater Iglesias, ^a J. Saidi, ^a M. Vicente Barreto Pinto, ^a S. Zambito, ^a L. Paolozzi, ^{a,b} and G. Lacobucci ^{a,1}
^a Département de Physique Nucléaire et Corpusculaire (DPNC), University of Geneva, 24 Quai Ernest Ansernet, CH-1211 Geneva 4, Switzerland ^b CERN, CH-1211 Geneva 23, Switzerland ^b CERN, CH-1211 Geneva 23, Switzerland ^c HittP — Leibniz-Institut für innovative Mikroelektronik, Im Technologiepark 25, Frankfurt (Oder), German, ^d Hiteh Energe Accelerator Research Organization, Oho 1, 1 Tsukuba, shi Ibaraki, ken, Ianon
Inga Energy Accelerator Research Organization, Ono 1-1, Isakuba-shi, Daraki-ken, Jupan E-mail: giuseppe.iacobucci@unige.ch
ABSTRACT: Samples of the monolithic silicon pixel ASIC prototype produced in 2022 within the framework of the Horizon 2020 MONOLITH ERC Advanced project were irradiated with 70 MeV protons up to a fluence of $1 \times 10^{16} n_{eq}/cm^2$, and then tested using a beam of 120 GeV/c pions
The ASIC contains a matrix of 100 μ m pitch hexagonal pixels, read out by low noise and very fas frontend electronics produced in a 130 nm SiGe BiCMOS technology process. The dependence on the proton fluence of the efficiency and the time resolution of this prototype was measured with the frontend electronics operated at a power density between 0.13 and 0.9 W/cm ² . The testbean data show that the detection efficiency of 99.96% measured at sensor bias voltage of 200 V befor irradiation becomes 96.2% after a fluence of $1 \times 10^{16} n_{eq}/cm^2$. An increase of the sensor bia voltage to 300 V provides an efficiency to 99.7% at that proton fluence. The timing resolution o 20 ps measured before irradiation rises for a proton fluence of $1 \times 10^{16} n_{eq}/cm^2$ to 53 and 45 ps a HV = 200 and 300 V, respectively.

• **TDC studies**, see [<u>1</u>, <u>2</u>]



• MALTA

https://twiki.cern.ch/twiki/bin/viewauth/Atlas/MaltaApprovedPlots#Time_resolution



Difference in time of the fastest hit of the cluster (matched with the track in the DUT) and the time of the hit in the scintillator (σ PMT \approx 1 ns not subtracted) for a MALTA non-irradiated sample Czochralski silicon with no modification (STD) versus substrate bias. Measurements were done with low energy electrons from Sr-90 β -decay

Jan. 19th 2023

Future Collider Requirements

Effective pile-up is defined as the number of pile-up vertices which effectively lead to a confusing assignment of low p^Ttracks to the original primary vertex



- Studies on primary vertexing at the FCC-hh demonstrate that 2D vertexing with an extreme timing resolution of 5 10 ps per track is essential to keep the levels of effective pile-up under control at large pseudorapidities (|η| > 3) which would otherwise reach level of tens or hundreds leading to large merging effects in vertex reconstruction and large confusion in vertex selection.
- Also: 30 times (600 times) more radiation compared to HL-LHC (LHC), making none of the existing technologies suitable

Jan. 19th 2023

V. M. M. Cairo

Timing in tracking detectors

CMS installing the timing layer outside the tracker: --

- σ_t = 30-60ps
- approved for the Phase 2 upgrade (\rightarrow 2027)
- 1 time measurement per track
- + 1 more forward hit in HGCAL

CMS might add 1-2 more timing layers closer to the IP

- σ_t = 30-60ps? ← depends on technology progress granularity + radiation hardness + material budget constraints
- conceptually possible for the Phase 3 upgrade (→2036) Inner Tracker will have to be replaced to sustain the radiation damage throughout the HL-LHC program

Full tracker made of fast Si considered for Muon Collider

- $\sigma_t = 20-50ps \leftarrow planning for the distant future (<math>\rightarrow 2035+$)
- primarily used for TOF-based rejection of BIB hits readout time windows tailored to sensor positions
- much more is possible with this timing information



CMS Phase 2/3 and Muon Collider

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https://indico.cern.ch/event/1048211/contributions/4413728/attachments/2274142/3862895/2021_06_30_bartosik_v0.pdf

Nazar Bartosik

V. M. M. Cairo

AC-Coupled LGADs

AC-Coupled Low Gain Avalance Diodes (AC-LGADs) [1, 2] are a new generation of silicon devices optimized for high-precision 4D tracking and conceived for experiments at future colliders. They are n-in-p sensors based on the LGAD technology with two additional key features (Figure 1): the AC-coupling of the read-out, occurring through a dielectric layer, and a continuous resistive n^+ implant. Given the presence of the resistive n^+ layer, AC-LGADs are called Resistive Silicon Detectors (RSD). RSD devices are provided with one continuous gain layer, and the read-out segmentation is obtained simply by the position of the AC pads; therefore, this design allows to reach 100% fill-factor.



Figure 1: Cross-section of RSDs internal structure: their properties are based on the combination of a resistive n^+ layer and a coupling dielectric oxide, allowing a local AC-coupling.

The remarkable feature of this design is that it leads naturally to signal sharing among pads. Internal signal sharing, in combination with internal gain, opens a new avenue for high precision tracking without relying only

https://arxiv.org/pdf/2007.09528.pdf

HGTD Rad. dose

HGTD TDR, fig. 2.15



This leads to a total safety factor of 1.5 for the sensors that are most sensitive to the particle fluence, and 2.25 for the electronics which are more sensitive to the TID. After applying these, the detector would need to withstand 8.3 × 1015 neq cm–2 and **7.5 MGy** (if the vessel is not replaced)

How to boost analysis sensitivity in HL-LHC?

VBF H->inv extensively studied at the time of the HGTD TDR, results still valid!



Figure 3.24: The dashed line shows the fraction of signal VBF $H \rightarrow$ invisible and Z+jet background events as a function of a m_{jj} threshold after a loose VBF preselection. Forward jets are those with $|\eta| > 2.4$. Solid (dotted) lines correspond to VBF $H \rightarrow$ invisible (Z+jet) events. The fraction of central-central, central-forward, and forward-forward events are shown in black, red, and blue colors respectively.

V. M. M. Cairo

DETECTOR LAYOUT STUDIES

A change in tracking technology would imply changes in material budget due to different power, cooling, data transmission etc and would require a re-evaluation of the optimal detector layout



OTHER ACTIVITIES

CERN has initiated studies on seeding to evaluate **CPU** gains with former student Steven Bos, and plans to continue <u>https://cds.cern.ch/record/2879352</u>



OTHER ACTIVITIES

DIPS algorithm with timing: https://cds.cern.ch/record/2908429

Vertex Grid seeder optimization <u>https://indico.cern.ch/event/1435014/contributions/6</u> 038249/attachments/2902452/5090667/Poster2024-<u>Nicollin.pdf</u>

RADIATION



Figure 2.18: The fluence and dose distributions for the Pixel Detector. **Top left**: 1 MeV neutron equivalent fluence. **Top right**: Total ionising dose. **Bottom left**: Charged particle fluence. **Bottom right**: Hadron fluence for energies greater than 20 MeV. The top two lots are normalised to 4000 fb⁻¹. No safety factors are taken into account for this Figure.

HL-LHC TRACKING

A detector designed to be pile-up robust, and algorthms designed to leverage such features



The lower the fake rate, the better the CPU and storage usage Improved IP resolution

More PU-robust vertexing

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HOW DOES HH LOOK IN HL-LHC?



HOW DOES HH LOOK IN HL-LHC?



27 11 24

HOW DOES HH LOOK IN HL-LHC?

Modern flavor tagging algorithms based on Graph Neural Networks fully exploit the potential of the ITk \rightarrow large sensitivity gains for HH!



RUN 3 *b***-TAGGING**



ILD TPC & TOF



Figure 3: From Ref. [19]. Particle separation power for π/k and K/p based on the dE/dx measurement in the TPC and on a time-of-flight estimator from the first ten ECAL layers. The separation power obtained when the information from the two systems is combined is also shown.

FCC

https://indico.in2p3.fr/event/32629/contributions/142638/attachmen ts/87407/131939/Sciandra ECFA2024 10 09 24.pdf

Charm Tagging & Light Rejection



- dN/dx dominates again, as expected from kinematic regime of ZH events
- Visible contribution from TOF, in absence of dN/dx

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Bottom Tagging & Light Rejection



- Most of PID gain from dN/dx, but...
- Significant contribution from TOF, with and without dN/dx!
 - Benchmark: 80% efficiency -> light rejection 4400 (dN/dx) vs. 5100 (dN/dx+mTOF)

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